

No.	LCP-1109027
Date	Jan 13 <sup>th</sup> 2010

## Technical Literature For TFT-LCD Module

# Model No. <u>LS013B4DN04</u>

Notice

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Mobile Liquid Crystal Display Group SHARP CORPORATION



#### NOTICE

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- Test and measurement equipment
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#### [For handling and system design]

(1) Handle with care as glass is used in this LCD panel. Dropping or contact against hard object may cause cracks or chips.

(2) Be careful to handle this LCD panel in order to avoid injury yourself by panel's edge as this panel is made of glass and might be a sharp edge.

(3) Do not scratch the surface of the UV protection film as it is easily damaged.

(4) Water droplets on the UV protection film must be wiped off immediately as they may cause color changes, or other defects if remained for a long time.

(5)Do not leave the LCD panel in direct sun or under ultraviolet ray.

(6) To clean LCD panel surface, wipe clean with absorbent cotton or soft cloth. If further cleaning is needed, use IPA (isopropyl alcohol) and wipe clean lightly on surface only. Do not use organic solvents as it may damage the LCD panel terminal area which uses organic material. Also, do not directly touch with finger. When the terminals cleaning are needed, those should be wiped by a soft cloth or a cotton swab without directly touching by hand.

(7) Do not expose gate driver, etc. on the panel (circuit area outside panel display area) to light as it may not operate properly. Design that shields gate driver, etc. from light is required when mounting the LCD module.

(8) To avoid circuit failure, do not touch panel terminal area.

(9) Support for the LCD panel should be carefully designed to avoid stress that exceeds specification on glass surface.
(10) When handling LCD module and assembling them into cabinets, be noted that storage in the environment of oxidization or deoxidization gas and the use of such materials as reagent, solvent, adhesive, resin, and etc. which generate these gasses, may cause corrosion and discoloration of LCD modules.

(11)To avoid picture uniformity failure, do not put a seal or an adhesive material on the panel surface.

(12) Do not use chloroprene rubber as it generates chlorine gas and affects reliability in LCD panel connective area.

(13) Protective film is attached to the surface of UV protection film on LCD panel to prevent scratches or other damages. Remove this protective film before use. In addition, do not attach the protective film which is removed from LCD module again. When the LCD panel which has the reattached protective film is needed to storage for a long time, the UV protection film might have a damage with picture quality failure.

(14) Panel is susceptible to mechanical stress and such stress may affect the display. Place the panel on flat surface to avoid stress caused by twist, bend, etc.

(15) When transporting LCD panels, secure them in LCD panel tray to avoid mechanical stress. The tray should be conductive to protect LCD panels from static charge.

Material used in set or epoxy resin (amine type hardening agent) from packaging, and silicon adhesive (dealcoholized or oxime) all release gas which may affect quality of UV protection film. Do confirm compatibility with user materials.

(16) As this LCD module is composed electronic circuits, it is sensitive to electrostatic discharge of 200V or more.Handle with care using cautions for the followings:

Operators

Operators must wear anti-static wears to prevent electrostatic charge up to and discharge from human body.



#### Equipment and containers

Process equipment such as conveyer, soldering iron, working bench and containers may possibly generate electrostatic charge up and discharge. Equipment must be grounded through 100Mohms resistance. Use ion blower.

Floor

Floor plays an important role in leaking static electricity generated in human body or equipment. If the floor is made of insulated material (such as polymer or rubber material), such static electricity may charge. Proper measure should be taken to avoid static electricity charge (electrostatic earth: 100Mohms). There is a possibility that the static electricity is charged to them without leakage in case of insulating floor, so the electrostatic earth: $1 \times 10^8 \Omega$  should be made.

Humidity

Humidity in work area relates to surface resistance of the persons or objects that generate electrostatics, and it can be manipulated to prevent electrostatic charge. Humidity of 40% or lower increases electrostatic earth resistance and promotes electrostatic charging. Therefore, the humidity in the work area should be kept above 40%. Specifically for film peeling process or processes that require human hands, humidity should be kept above 50% and use electricity removal blower.

#### Transportation/Storage

Containers and styroform used in transporation and storage may charge electrostatic (from friction and peeling) or electrostatic charge from human body, etc. may cause containers and styroform to have induced charge. Proper electrostatic measure should be taken for containers and storage material.



### [For operating LCD module]

(1) Do not operate the LCD panel under outside of electrical specification. Otherwise LCD panel may be damaged.(2) Do not use the LCD panel under outside of specified driving timing chart. Otherwise LCD panel may not have proper picture quality.

(1) Do not operate the LCD panel under outside of electrical specification. Otherwise LCD panel may be damaged.

(2) Do not use the LCD panel under outside of specified driving timing chart. Otherwise LCD panel may not have proper picture quality.

(3) A still image should be displayed less than two hours, if it is necessary to display still image longer than two hour, display image data must be refreshed in order to avoid sticking image on LCD panel.

(4) If LCD module takes a static electricity, as the display image which is written into pixel memory might not be displayed, Data update should be executed frequently.

### [Precautions for Storage]

(1) After opening the package, do not leave the LCD panel in direct sun or under strong ultraviolet ray. Store in dark place.

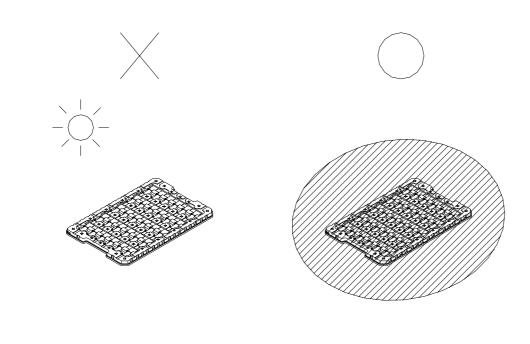
(2) In temperature lower than specified rating, liquid crystal material will coagulate. In temperature higher than specified rating, it isotropically liquifies. In either condition, the liquid crystal may not recover its original condition. Store the LCD panel in at or around room temperature as much as possible.

Also, storing the LCD panel in high humidity will damage the polarizer. Store in normal room temperature as much as possible.

#### (3) Keeping Method

a. Don't keeping under the direct sunlight.

b. Keeping in the tray under the dark place.





#### [Other Notice]

- (1) Operation outside specified environmental conditions cannot be guaranteed.
- (2) As power supply (VDD-VSS, VDDA-VSSA) impedance is lowered during use, bus controller should be inserted near LCD module as much as possible.
- (3) UV protection film is applied over LCD panel surface. Liquid crystal inside LCD panel deteriorates with ultraviolet ray. The panel should not be left in direct sun or under strong ultraviolet ray for prolonged period of time even with the UV protection film.
- (4) Disassembling the LCD module will cause permanent damage to the module. Do not disassemble the module.
- (5) If LCD panel is broken, do not ingest the liquid crystal from the broken panel. If hand, leg, or clothes come in contact with liquid crystal, wash off immediately with soap.
- (6) ODS (specific chlorofuorocarbon, specific halon, 1-1-1 trichloroethane, carbon tetrachloride) are not used or contained in material or all production processes of this product.
- (7) Observe all other precautionary requirements in handling general electronic components.

#### **Discarding liquid crystal modules**

LCD Panel : Dispose of as glass waste. This LCD module contains no harmful substances.

The liquid crystal panel contains no dangerous or harmful substances.

This liquid crystal panel contains only an extremely small amount of liquid crystal (approximately 100mg) and therefore it will not leak even if the panel should break.

Its median lethal dose (LD50) is greater than 2,000 mg/kg and a mutagenetic (Aims test: negative) material is used.

FPC : (1) FPC bend R should be 0.45mm or greater and R should be even.

In LCD panel an connective area, do not bend FPC into UV protection film side. (2)Do not hang LCD module by FPC or apply force to FPC.

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#### 1. Outline

This TFT-LCD module is a reflective active matrix memory liquid crystal display module with CG silicone thin film transistor. Module outline is indicated in fig 8-1.

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#### 2. Characteristics

- Reflective panel of white and black with aspect ratio of 1:1
- 1.3" screen has 96x 96 resolusion. (9216 pixels stripe array)
- Display control by serial data signal communication.
- Arbitrary line data renewable.
- 1bit internal memory for data storage within the panel.
- Thin, light-weight and compact module with monolithic technology.
- Super low power consumption TFT panel.
- FPC attached (Applicable connectors: Please refer to the page 21 "Recommended Connectors"

#### 3. Mechanical Specification

#### Table 3-1

Item	Specification	unit
Screen size	3.4 (1.3")	cm
Viewing Area	24.192 (H) × 24.192 (V)	mm
Dot configuration	96 (H) × 96 (V)	Dot
Dot pitch	0.252 (H) × 0.252 (V)	mm
Pixel Array	Stripe Array	-
Outline Dimension	28.2 (W) × 32.34 (H) × 1.40 (D)	mm
Mass	3.6 (TYP)	g
Surface Hardness	3H	Pencil hardness

(Note) Detail dimension and tolerance are shown in fig. 8-1

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4. Ing	out	terminal	names	and	functions

Table4-1				
Terminal	symbol	1/0	Function	Remark
1	SCLK	INPUT	Serial clock signal	
2	SI	INPUT	Serial data input signal	
3	SCS	INPUT	Chip select signal	
4	EXTCOMIN	INPUT	External COM inversion signal input (H: enable)	
5	DISP	INPUT	Display ON/OFF signal	[Remark4-2]
6	VDDA	POWER	Power supply (Analog)	
7	VDD	POWER	Power supply (Digital)	
8	EXTMODE	INPUT	COM inversion select terminal	[Remark4-1]
9	VSS	GND	GND(Digital)	
10	VSSA	GND	GND(Analog)	

[Remark4-1] When it's "H", EXTCOMIN signal is enable. And when it's "L", sirial input flag is enable.

[Remark4-1] When it's "H", EXTCOMIN signal is enable. And when it's "L", sirial input flag is enable.

"H"mode; connect the EXTMODE toVDD, "L" mode; connect the EXTMODE to VSS.

[Remark4-2] The display ON/OFF signal is only for display. Data in the memory will be saved at the time of ON/OFF. When it's "H", data in the memory will display, when it's "L", white color will diaplay and data in the memory will be saved.

4-2) Recommended circuit;

#### COM Signal Serial Input EXTMODE=L

	1	SCLK
	2	SI
	3	SCS
	4	EXTCOMIN
	5	DISP
	- 6	VDDA
	7	VDD
	8	EXTMODE
-	9	VSS
	10	VSSA

#### External COM Signal Input EXTMODE=H

 1	SCLK
 2	SI
 3	SCS
 4	EXTCOMIN
 5	DISP
 6	VDDA
 7	VDD
8	EXTMODE
 . 9	VSS
 10	VSSA

#### 5. Absolute Maximum Rating

		-
Table5-1	(GND = 0V)	

	Item	Symbol	MIN.	MAX.	Unit	Remark
Power	Analog	VDDA	-0.3	+ 3.6	V	
supply voltage	Logic	VDD	-0.3	+ 3.6	V	[Remark5-1]
Input sign	al voltage(high)			VDD	V	[Remark5-2]
Input sign	al voltage(low)		-0.3		V	
Strage Te	mperature	Tstg	TBD	TBD	C°	[Remark5-3,4]
Operation (at panel s	Temperature surface)	Topr1	-10	+ 60	°C	[Remark5-5]

[Remark5-1] Applies to EXTMODE.

[Remark5-2] Applies to SCLK, SI, SCS, DISP, EXTCOMIN.

[Remark5-3] Do not exceed this temperature in any parts of module.

 $[{\sf Remark 5-4}]$  Maximum wet bulb temperature is 57°C  $\,$  or lower. No condensation is allowed.

Cndensation will cause electeical leak and may cause the module to not meet this specification.

[Remark5-5] Operating temperature is the temperature that guarantees only for the operation.

For contrast, response time, and other display quality determination, use Ta = +25°C.

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#### 6. Electrical characteristics

#### 6-1) TFT LCD panel drive

Table6-1 Recommended operating Condition

#### VSS(GND) = 0V, Ta = + 25°C

Item		symbol	MIN.	TYP.	MAX.	Unit	Remark
Power supply	Analog	VDDA	+ 2.7	+ 3.0	+ 3.3	V	
	Logic	VDD	+ 2.7	+ 3.0	+ 3.3	V	[Remark6-1]
Input signal voltage	Hi	VIH	VDD-0.1		VDD	V	[Remark6-2]
	Lo	VIL	VSS		VSS+0.1	V	

[Remark6-1] Applies to EXTMODE = "H"

[Remark6-2] Applies to SCLK, SI, SCS, DISP, EXTCOMIN.

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6-2) Power supply seque	ence			
	On Sequence	Normal operation	Off sequence	
VDD/VDDA(5V)			GND	

Normal operation

Normal operation

Normal operation

2

2

Refer to timing chart and AC timing characteristics for detail

2

2

1 and may be opposite (however, TCOM polarity inversion will not occur even with EXTCOMIN between DISP="L". Also, when DISP and EXTCOMIN are simultaneously started up, allow 30us or more before SCS starts up (It may be less than 60us).

GND

GND

GND

GND

2 Setting value for pixel memory initialization

SCS=Driving accordingly to clear pixel internal memory method (use all clear flag or write all screen white)

S1=M2 (all clear flag) = "H" or write white

SCLK: Normal Driving

DISP

SCS

Others

**EXTCOMIN** 

#### [ON Sequence]

GND

GND

GND

GND

(1) 3V rise time (depends on IC)

(2) Pixel memory initialization T2: 1V or more Initialize with M2 (all clear flag) or write all screen white

(3) Release time for initialization of TCOM latch T3: 30us or more

Time required to release COM related latch circuit initialization which is initializing using DISP signals

(4) TCOM polarity initialization time T4: 30us or more

Time required initializing TCOM polarity accordingly to EXTCOMIN input

[Normal Operation]

Duration of normal driving

[Off Sequence]

- (5) Pixel memory initialization time T5: 1V or more
- (6) VA, VB, VCOM initialization time T6: 1V or more
- (7) 3V falling time (Depends on IC)

[Remark] Precaustions at ehte time of power on and power off.

Remark 1)When power on , VDD and VDDA are same time or VDD should be faster than the VDDA. Remark 2) When power off, VDD and VDDA are same time or VDDA should be faster than the VDD.

PAGE

#### 6-3) Input signal characteristics

Table6-3-1	VDDA= + 3.0V, VDD= + 3.0V, VSS=0V, VSSA=0V, Ta=25°C					
Item	Symbol	MIN	TYP	MAX	Unit	Remark
Frame frequency	fSCS	1	-	60	Hz	
Clock frequency	fSCLK		0.5	1	MHz	
Vertical Interval	tV	16.66	-	1000	ms	
COM Frequency	fCOM	0.5	-	30	Hz	

Table 6-3-2

VDDA= + 3.0V, VDD= + 3.0V, VSS=0V, VSSA=0V, Ta=25°C

Item	Symbol	MIN	TYP	MAX	Unit	Remark
SCS Rising time	trSCS	-	-	50	ns	
SCS Falling Time	tfSCS	-	-	50	ns	
SCS High duration	twSCSH	136	-	-	us	
		24	-	-	us	
SCS Low duration	twSCSL	2	-	-	us	
SCS set up time	tsSCS	6	-	-	us	
SCS hold time	thSCS	2	-	-	us	
SI Rising time	trSI	-	-	50	ns	
SI Falling time	tfSI	-	-	50	ns	
SI set up time	tsSI	380 *1	-	-	ns	
SI hold time	thSI	440 *1	-	-	ns	
SCLK Rising time	trSCLK	-	-	50	ns	
SCLK Falling time	tfSCLK	-	-	50	ns	
SCLK High duration	twSCLKH	450	950	-	ns	
SCLK Low duration	twSCLKL	450	950	-	ns	
EXTCOMIN signal freequency	<b>fEXTCOMIN</b>		1	60	Hz	[Remark6-3]
EXTCOMIN signal rising time	trEXTCOMIN	-	-	50	ns	
EXTCOMIN signal falling time	tfEXTCOMIN	-	-	50	ns	
EXTCOMIN signalHigh duration	twEXTCOMINH	2			us	
DISP Rising time	trDISP	-	-	50	ns	
DISP Folling time	tfDISP	-	-	50	ns	

[Remark 6-3] EXTCOMIN frequency should be made lower than frame frequency.

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SCS, SI, SCLK signal	twSCSH //	twSC	SL
SCS 50%	<b>\$</b>	90% 50% 10% thSCS tfSCS	50%
	ttSI		
SCLK	50% 50%	50%	
EXTCOMIN signal	, fEXTCOMIN		
EXTCOMIN 90% 90% 10%	50%	50%	
DISP signal			
DISP			
SCS,SI,SCLK、DISP、EXTCOMIN	I: 3V input voltage		



#### 6-4) Power consumption (Average)

Table6-4						Ta = 25°C
Item	Symbol	MIN	TYP	MAX	unit	Remark
Condition1			6	TBD	uW	[Remark6-4]
Condition2			12	TBD	uW	[Remark6-4]

\* Measurement Condition 1

Display mode (no display data update),

Common inversion fSCS=1Hz, with VDD=3V, VDDA=3V, fSCLK=0.5MHz, Display pattern: Vertical stripe display \* Measurement Condition 2

Data update mode (with display data update: 1Hz)

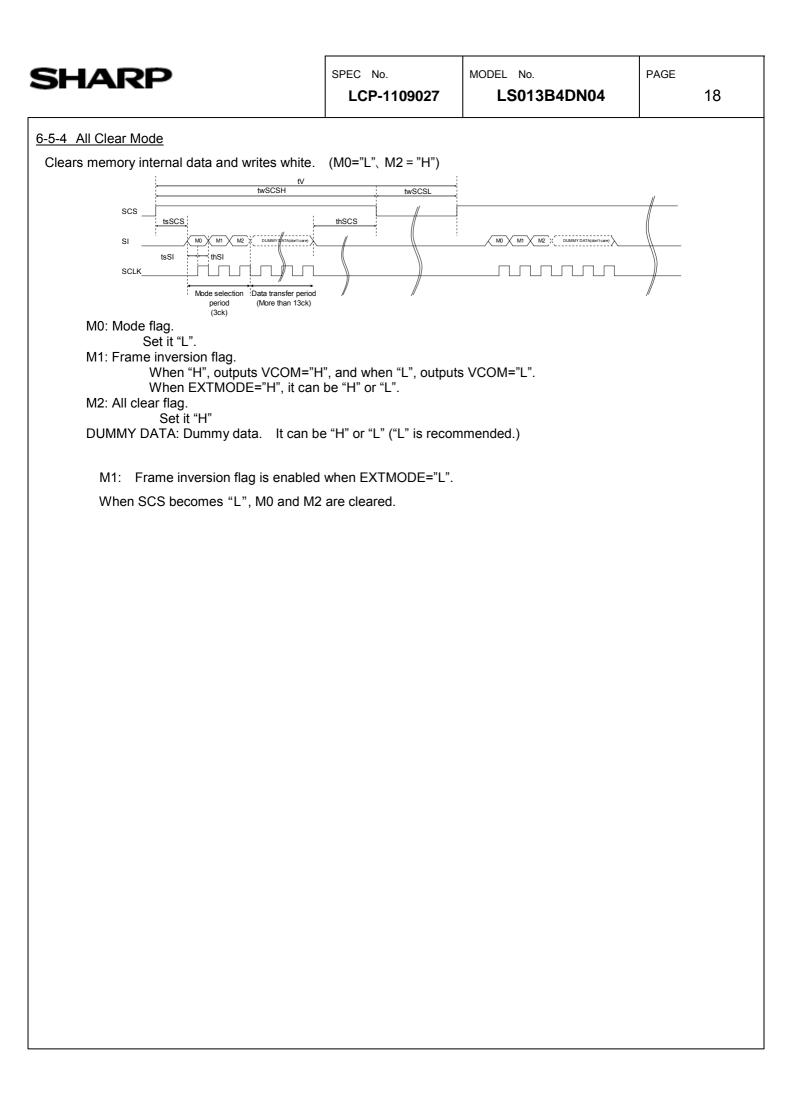
Common inversion fSCS=1Hz with VDD=3V, VDDA=3V, fSCLK=0.5MHz, Display pattern: Vertical stripe display

[Remark 6-4] This is value in steady condition, not the falue of peak power at the time of COM operation. Some marging for power supply is recommended. We recommend capacitor for VDD and VDDA. (If VDD and VDDA are on separate systems, we recommend capacitor for each.)

M0: Mode flag. Set for "H". Data upo When "L", display mode M1: Frame inversion flag. When "H", outputs VCO When EXTMODE="H", i M2: All clear flag.	date mode (Memory interna (geck) (geck) (geck) (ata mode (Memory internal (maintain memory internal M="H", and when "L", output it can be "H" or "L". r Mode to execute clear. can be "H" or "L" ("L" is reco	Data transfer period (16ck) al data update) data). uts VCOM="L".	thSCS
Updates data of only one specified line.	date mode (Memory interna (maintain memory internal M="H", and when "L", output it can be "H" or "L". r Mode to execute clear. can be "H" or "L" ("L" is reco	Data transfer period (16ck) al data update) data). uts VCOM="L".	i
MO: Mode flag. Set for "H". Data upo (3ck+5ckDMy) Gate line address period (3ck+5ckDMy) Gate line address period (7ck+1ckDMy) MO: Mode flag. Set for "H". Data upo (7ck+1ckDMy) M1: Frame inversion flag. When "H", outputs VCO When EXTMODE="H", i M2: All clear flag. Refer to 6-5-4) All Clear DUMMY DATA: Dummy data. It	date mode (Memory interna (geek) M="H", and when "L", output it can be "H" or "L". r Mode to execute clear. can be "H" or "L" ("L" is reco	Data transfer period (16ck) al data update) data). uts VCOM="L".	i
M0: Mode flag. Set for "H". Data upo When "L", display mode M1: Frame inversion flag. When "H", outputs VCO When EXTMODE="H", i M2: All clear flag. Refer to 6-5-4) All Clear DUMMY DATA: Dummy data. It	date mode (Memory interna (geek) M="H", and when "L", output it can be "H" or "L". r Mode to execute clear. can be "H" or "L" ("L" is reco	Data transfer period (16ck) al data update) data). uts VCOM="L".	<u> </u>
When "L", display mode M1: Frame inversion flag. When "H", outputs VCO When EXTMODE="H", i M2: All clear flag. Refer to 6-5-4) All Clear DUMMY DATA: Dummy data. It	(maintain memory internal M="H", and when "L", output it can be "H" or "L". r Mode to execute clear. can be "H" or "L" ("L" is reco	data). uts VCOM="L".	
	od	ommonded \	
		ommended.)	
Data is being stor Data transfer pe	eriod	ry driver on panel. written) to pixel internal memo	orv circuit
For gate line address setting, refe	er to 6-6) Input Signal and D	Display.	
M1: Frame inversion fl is enaled	I when EXTMODE="L".		
When SCS becomes "L", M0 and	M2 are cleared.		

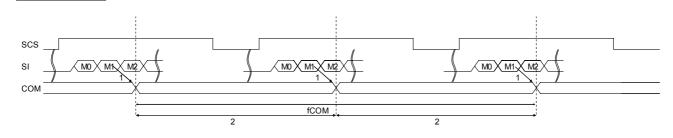
SHARP	SPEC No. LCP-1109027	MODEL No. LS013B4DN04	PAGE 16
6-5-2 Data Update Mode (Multiple Lines) Updates arbitrary multiple lines data. (M0="H	H"、M2 = "L")		
twSCSH		il d	d -
SCS		rperiod Data transfer pe	ck(Dummy)=16ck)
	writing period Data tra	MY 0 TA(dont care)	twSCSL
M0: Mode flag. Set for "H". Data update When "L", display mode (ma M1: Frame inversion flag. When "H", outputs VCOM="H When EXTMODE="H", it car M2: All clear flag. Refer to 6-5-4) All Clear Mo DUMMY DATA: Dummy data. It can Data write period Data is being stored in 1 <sup>st</sup> latch Data transfer period For example, during GL2	intain memory internal of H", and when "L", output h be "H" or "L". de to execute clear. be "H" or "L" ("L" is reco	data). ts VCOM="L". mmended.)	latched and GI 1st
line data is transferred fro	om 1 <sup>st</sup> latch to pixel inter	rnal memory circuit at the sam	e time.
For gate line address setting, refer to	6-6) Input Signal and D	isplay.	
Input data continuously.			
M1: Frame inversion flag is enabled			
When SCS becomes "L", M0 and M2	2 are cleared.		

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6-5-3 Display Mode			
Maintains memory internal data (maintains curr	ent display). (M0="L"、	M2 = "L")	
tV twSCSH		twSCSL	<i>i</i> l
SCS	thSCS		
		M0 X M1 X M2 X 1	JUMMY DATA(don't care)
tsSI ++++++++++++++++++++++++++++++++++++			
<sup>(3ck)</sup> M0: Mode flag. Set for "H". Data update	mode (Memory interna	l data update)	
When "L", display mode (ma			
M1: Frame inversion flag. When "H", outputs VCOM="I		its VCOM="L".	
When EXTMODE="H", it car M2: All clear flag.	ו be "H" or "L".		
Refer to 6-5-4) All Clear Mo		ammonded )	
DUMMY DATA: Dummy data. It can		ommended.)	
M1: Frame inversion flag is enabled w When SCS becomes "L", M0 and M2 a			



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6-5-5 COM Inversion			

There are two types of inputs, COM signal serial input (EXTMODE="L") and external COM signal input (EXTMODE="H"). EXTMODE="L"



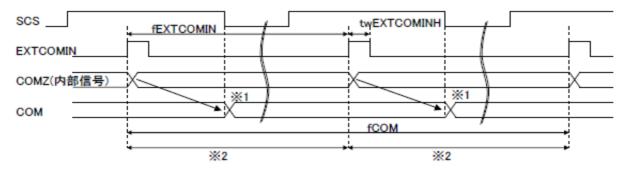
M1:LC polarity inversion flag: If M1is "H" then VCOM="H" is output. If M1 is "L" then VCOM="L" is output.

1:LC inversion has been changed by M1 flag statement.

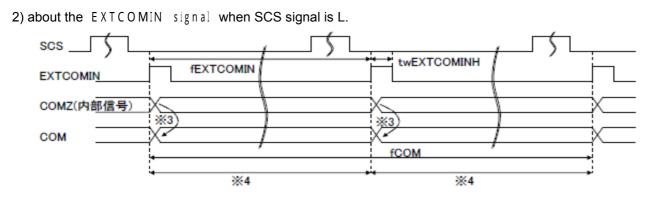
2: The periods of plus polarity and minus polarity should be same length as much as possible.

#### EXTMODE="H"

1) about the EXTCOMIN signal when SCS signal is H.



1:LC inversion polarity has been set by the rising timing of EXTCOMIN in internal circuit block as COMZ signal, 2: The period of EXTCOMIN should be constant.



3:LC inversion polarity has been set by the rising timing of EXTCOMIN in internal circuit block as COMZ signal, 4: The period of EXTCOMIN should be constant.

SH/	AR	P			SPEC No. LCP-110902	27	MODEL No. LS013B4DN04	PAGE 20
				address(Line)	Setting			
Data posit	ion in di	splay(H,	V]					
				UP				
ſ	P1,L1	P2,L1	P3,L1		P96,L1			
	P1,L2	P2,L2		]				
	P1,L3		I					
				Display side up				
F	P1,L96				P96,L96			

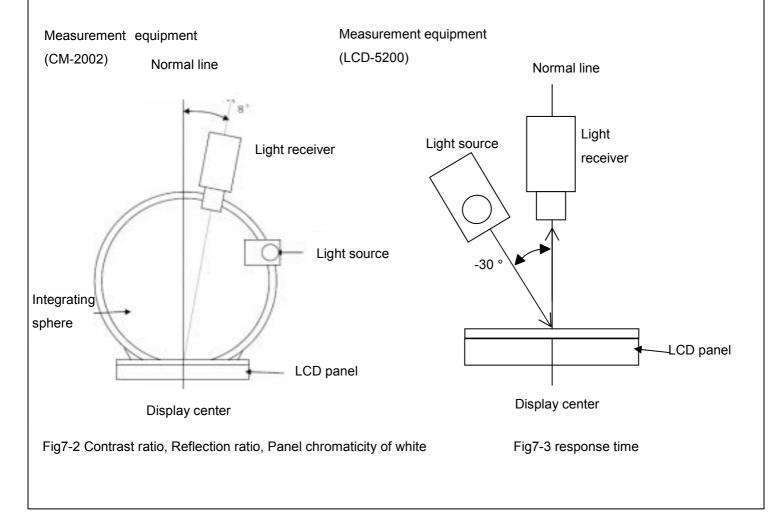
	AG0	AG1	AG2	AG3	AG4	AG5	AG6
L1	Н	L	L	L	L	L	L
L2	L	Н	L	L	L	L	L
L3	Н	Н	L	L	L	L	L
•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•
•	•	•	•	•	•	•	•
L94	L	Н	Н	Н	Н	L	Н
L95	Н	Н	Н	Н	Н	L	Н
L96	L	L	L	L	L	Н	Н

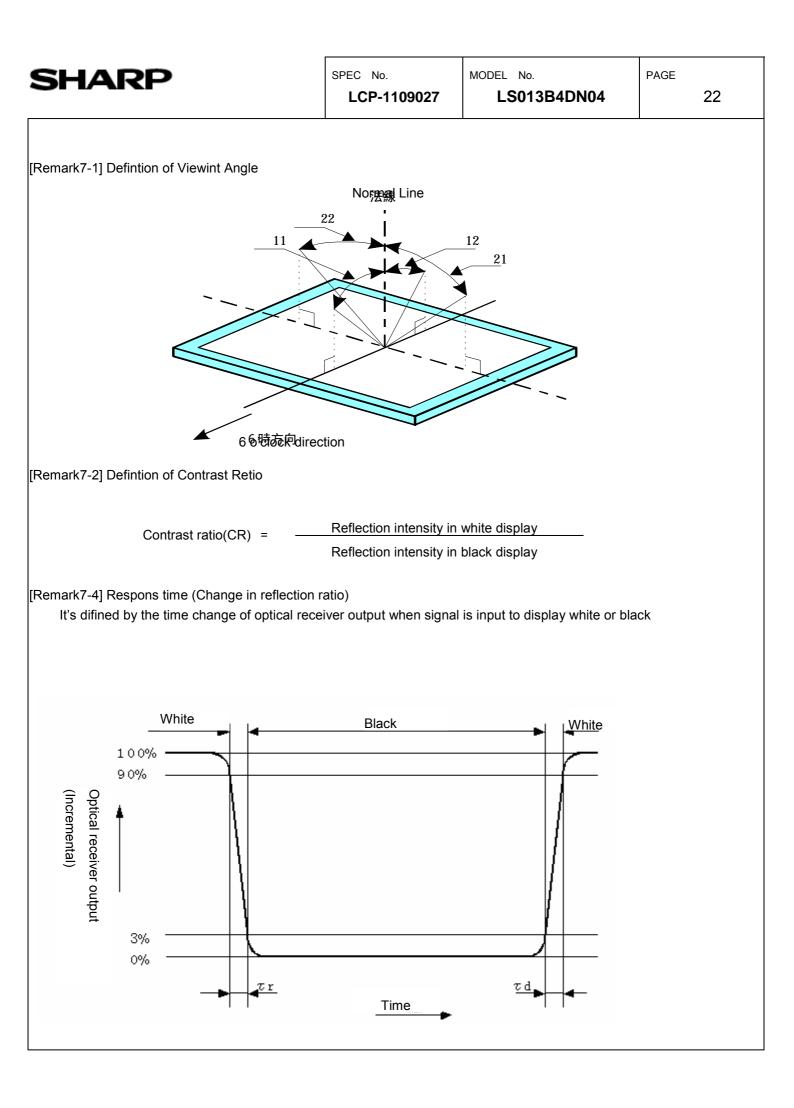
#### 7. Optical characteristics

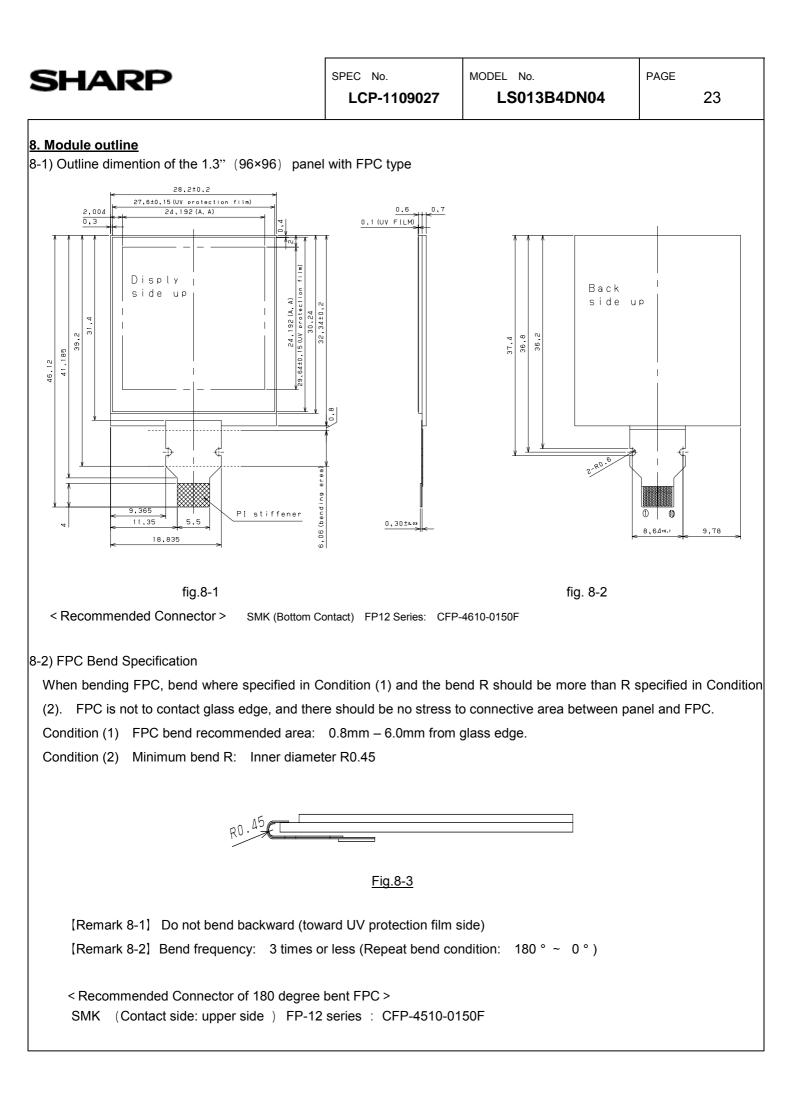
Table 7-1							Ta=25°0
Item		Symbol	MIN.	TYP.	MAX.	unit	Remark
Viewing angle	Н	021,022	60			°(degree)	[Remark7-1]
CR 3	V	θ11	60			°(degree)	
		θ12	60			°(degree)	
Contrast ratio		CR.	5	10			[Remark7-2、3]
Reflecivity ratio		R		50		%	[Remark7-3]
Response time	Rise	Tr		50		ms	[Remark 7-3,4]
	Fall	тd		50		ms	
Panel	White	x		0.313			[Remark7-3]
Chromaticity		У		0.338			

[Remark7-3] Optical characteristics measurement equipment.

Figure 7-2 is for contrast ratio, reflectivity ratio, and panel chromaticity measurement, and figure 7-3 is for response time measurement. Both are to be conducted in a dark or room equivalent to a dark room







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#### 9. External capacitors

		1	SCLK
		2	SI
		3	SCS
		4	EXTCOMIN
		5	DISP
_ I <del></del>		6	VDDA
		7	VDD
_ <del>+</del> + =	÷ —	8	EXTMODE
		9	VSS
		10	VSSA
C1 C2	C3		

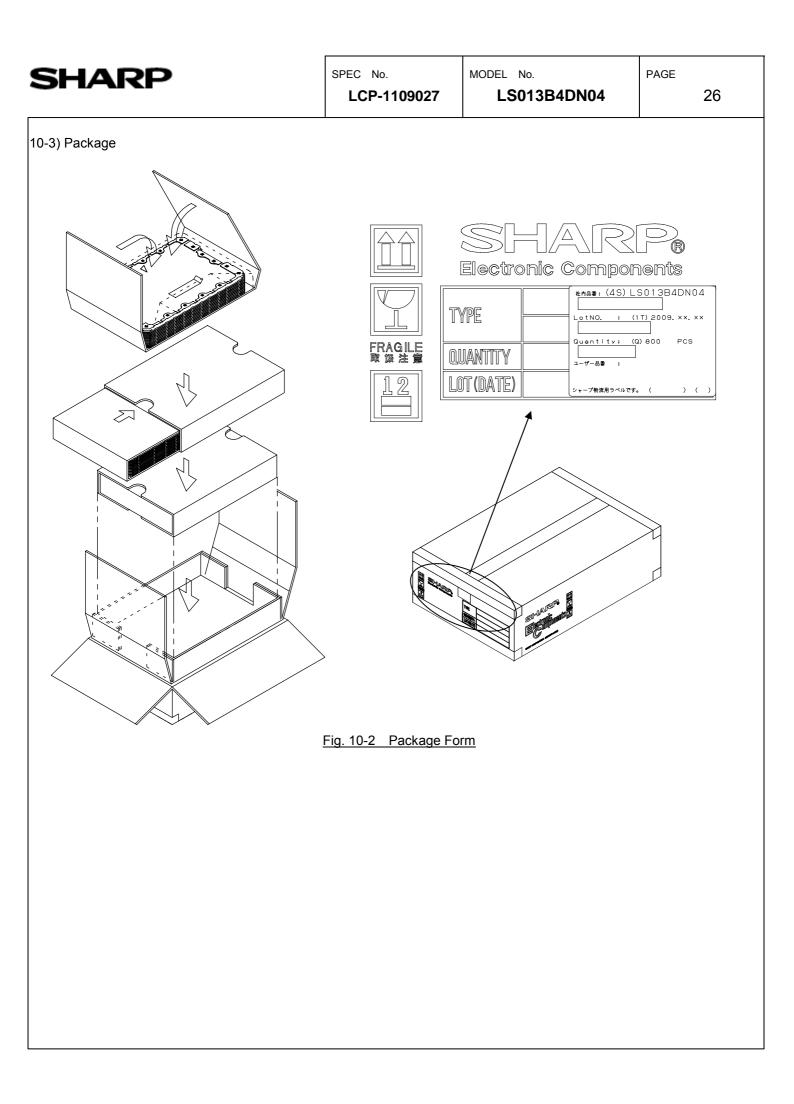
#### Fig. 9-1 External capacitor recommendation capacity value

- < Recommended capacity value >
  - C1: DISP- VSS: rank B 0.1uF Ceramic capacitor C2: VDDA- VSS: rank B 1uF Ceramic capacitor C3: VDD- VSS: rank B 1uF Ceramic capacitor

Above circuit and parts are only recommendation.

For actual use, please evaluate their conformity with your system and design. (Capacitor pressure resistance can be larger than resistance indicated above.)

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10. Package			
10-1) Serial number (Ink-jet print) will be indica	ted on serial number la	abel as indicated in Figure 10	0-1 outline dimensior
figure.			
Mo	del number		
			$\mathcal{O}$
LS013B4DN04			
Print structure 9312AD00001FA		LS013 9312A	B4DN04
	Display side up		ack de up
ABC D			•
Serial number specifications	2 5	<pre> </pre>	5
A∶a single figure of the year			
B:month(1,29,X,Y,Z)			
C∶day			
D:serial number			
<u>Fig. 10</u>	)-1 Serial number print	position	
10-2) Forwarding form 1) Piling number of cartons : Max 12			
Package quality in a carton : 8	00pcs		
2) Storage condition			
· Temperature: 0~4	10		
· Humidity: 60%RH			
		at low temperature and high	humidity.
		or alkali, which causes sever	-
	l wiring, are to be detect		
Period: About 3 mo	-		
· Opening the package	ge: in order to prevent e made over 50%RH and	electrostatic damage to TFT m take effective measure such a	





#### 11. Reliability Test Conditions

#### 11-1) Reliability test items

#### Table11-1

	Test Item	Test condition	Remark
1	High temperature storage test	Ta=80degrees Celsius 240h	
2	Low temperature storage test	Ta=35degrees Celsius 240h	
3	High temperature and high humidity operating test	Tp=40degrees Celsius/95%RH 240h	
4	High temperature operating test	Tp=70degrees Celsius 240h	
5	Low temperature operating test	Tp=-20degrees Celsius 240h	
6	Shock test (Non operating test)	Ta=-30degrees Celsius (1h) ~ +80 degrees Celsius (1h) / 5 cycle	
7	Electro static discharge test	$\pm 200V$ , 200pF(0 $\Omega$ ) each terminai: 1 time	

[Remark] Ta = Ambient temperature, Tp = Panel temperature

(Evaluation method)

In the standard condition, there shall be no practical problems that may affect the display function.

#### 11-2) Panel surface stress spesification

Panel surface stress spesification has been defined as a parameter "Force of stress [N]" without no picture failer. Load testing: Minimum 120[N]

Test condition )

Test stracture	LCD panel with UV protection film
Press point	Center of LCD panel
Press Jig	:φ10mm column
Press speed	:1mm / minute
Support	: fixed on stage
Press time	:5 seconds after achivement of the press strength, then reless it.